MA21D34

Silicon epitaxial planar type

For rectification

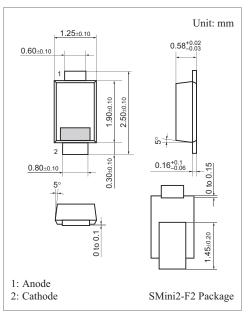
Features

- Forward current (Average) $I_{F(AV)} = 1.0 \text{ A rectification is possible}$
- Low forward voltage V_F

Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter | Symbol | Rating | Unit | |
|---------------------------------------------|---------------------|-------------|------|--|
| Reverse voltage | V _R | 30 | V | |
| Maximum peak reverse voltage | V _{RM} | 30 | V | |
| Forward current (Average) | I _{F(AV)} | 1.0 | А | |
| Non-repetitive peak forward surge current * | I _{FSM} 20 | | А | |
| Junction temperature | Tj | 150 | °C | |
| Storage temperature | T _{stg} | -55 to +150 | °C | |

Note) *: 50 Hz sine wave 1 cycle (Non-repetitive peak current)



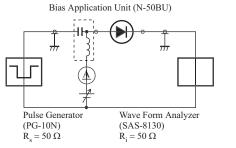
Marking Symbol: 4V

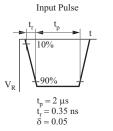
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------------------|-----------------|-----------------------------------------------------------------------------------------------|-----|------|-------|------|
| Forward voltage V_{F1} V_{F2} | V _{F1} | $I_F = 0.7 A$ | | 0.33 | 0.36 | V |
| | V _{F2} | $I_F = 1.0 A$ | | 0.35 | 0.38 | |
| Reverse current | I _R | $V_{R'} = 30 V$ | | | 1 200 | μΑ |
| Terminal capacitance | Ct | $V_{RJ} = 10 V, f = 1 MHz$ | | 45 | | pF |
| Reverse recovery time * | t _{rr} | $I_{\rm F} = I_{\rm R} = 100 \text{ mA}, I_{\rm m} = 10 \text{ mA},$ $R_{\rm L} = 100 \Omega$ | | 14 | | ns |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. *: t_{rr} measurement circuit





Output Pulse



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